Refine Search Search Results -Documents **Terms** L2 and (stop? near2 polymer) US Pre-Grant Publication Full-Text Database US Patents Full-Text Database US OCR Full-Text Database Database: EPO Abstracts Database JPO Abstracts Database **Derwent World Patents Index** IBM Technical Disclosure Bulletins L3 Refine Search Search: Recall Text = Interrupt Clear

Search History

DATE: Monday, March 22, 2004 Printable Copy Create Case

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<u>L3</u>	L2 and (stop? near2 polymer)	1	<u>L3</u>		
<u>L2</u>	L1 and cmp	1269	<u>L2</u>		
<u>L1</u>	(polishing or polish) near2 (stop or stopper)	1869	<u>L1</u>		

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1. Document ID: US 6417116 B2

L4: Entry 1 of 2

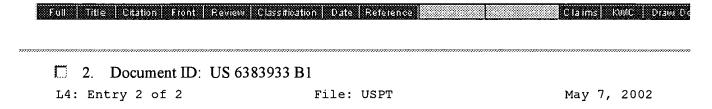
File: USPT

Jul 9, 2002

US-PAT-NO: 6417116

DOCUMENT-IDENTIFIER: US 6417116 B2

TITLE: Semiconductor device having a multilayer interconnection structure



US-PAT-NO: 6383933

DOCUMENT-IDENTIFIER: US 6383933 B1

TITLE: Method of using organic material to enhance STI planarization or other

planarization processes

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Previous Page

Next Page

Go to Doc#

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Search Results - Record(s) 1 through 1 of 1 returned.

1. Document ID: US 6383933 B1

L3: Entry 1 of 1

File: USPT

May 7, 2002

US-PAT-NO: 6383933

DOCUMENT-IDENTIFIER: US 6383933 B1

TITLE: Method of using organic material to enhance STI planarization or other

planarization processes

Full Title Citation Front Review Classification Dat	e Reference Claims KWC Draw C
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L2 and (stop? near2 polymer)	

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Previous Page

Next Page

Go to Doc#